Onsemi

MOSFET - Power, Single N-Channel, SUPERFET[®] V, FRFET[®], TO247-3L 600 V, 40 mΩ, 59 A

NVHL040N60S5F

Description

The SUPERFET V MOSFET FRFET series has optimized body diode performance characteristics. This can allow for the removal of components in the application and improve application performance and reliability, particularly when soft switching topologies are used.

Features

- 650 V @ $T_J = 150^{\circ}C / Typ. R_{DS(on)} = 32 m\Omega$
- 100% Avalanche Tested
- Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Electric Vehicle On Board Chargers
- EV Main Battery DC/DC Converters

ABSOLUTE MAXIMUM RATINGS (T_{.1} = 25°C, Unless otherwise noted)

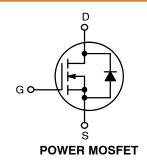
Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	600	V
Gate-to-Source Voltage	DC	V _{GSS}	±30	V
	AC (f > 1 Hz)		±30	
Continuous Drain Current	T _C = 25°C	I _D	59	А
	$T_{C} = 100^{\circ}C$		37	
Power Dissipation	T _C = 25°C	PD	347	W
Pulsed Drain Current (Note 1)	T _C = 25°C	I _{DM}	209	А
Pulsed Source Current (Body Diode) (Note 1)	$T_C = 25^{\circ}C$	I _{SM}	209	A
Operating Junction and Storage Range	T _J , T _{STG}	–55 to +150	°C	
Source Current (Body Diode)		I _S	59	А
$ \begin{array}{ll} \mbox{Single Pulse Avalanche} & \mbox{I}_L = 8.3 \mbox{ A}, \\ \mbox{Energy} & \mbox{R}_G = 25 \ \Omega \end{array} $		E _{AS}	574	mJ
Avalanche Current	I _{AS}	8.3	А	
Repetitive Avalanche Energy (N	E _{AR}	3.47	mJ	
MOSFET dv/dt		dv/dt	120	V/ns
Peak Diode Recovery dv/dt (No		70		
Lead Temperature for Soldering Purposes (1/8" from case for 10 seconds)		ΤL	260	°C

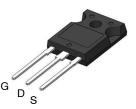
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

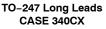
1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. $I_{SD} \le 29.5$ A, di/dt ≤ 200 A/µs, $V_{DD} \le 400$ V, starting $T_J = 25^{\circ}C$.

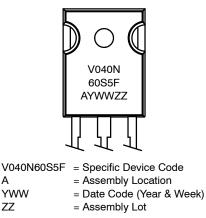
V _{DSS}	R _{DS(ON)} MAX	I _D MAX
600 V	40 mΩ @ 10 V	59 A







MARKING DIAGRAM



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ORDERING INFORMATION

Device	Package	Shipping
NVHL040N60S5F	TO-247	30 Units / Tube

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case, Max.	$R_{ ext{ heta}JC}$	0.36	°C/W
Thermal Resistance, Junction-to-Ambient, Max.	$R_{ hetaJA}$	40	

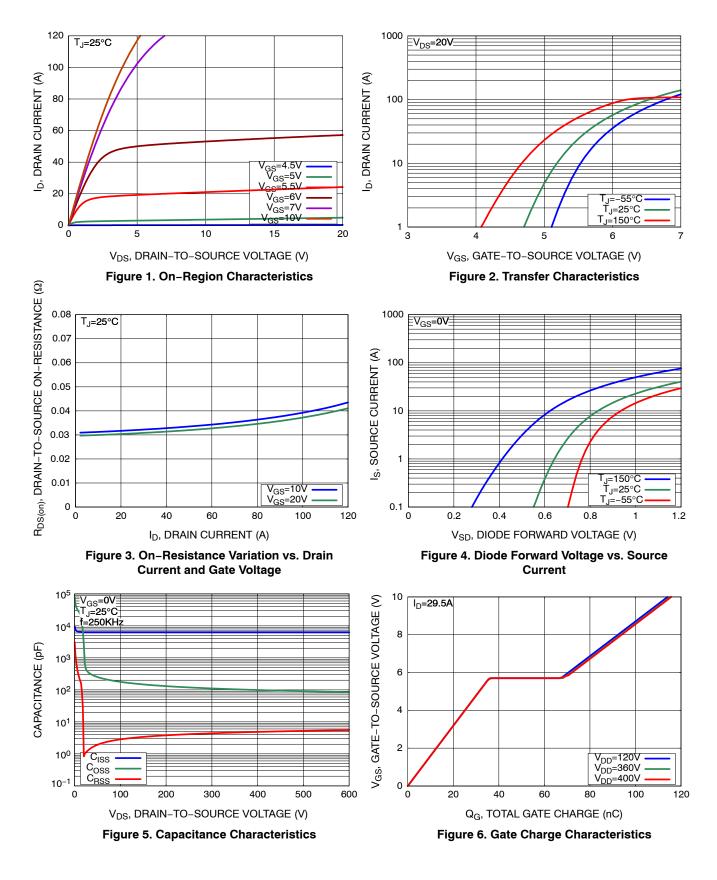
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	600	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_J$	I_D = 10 mA, Referenced to 25°C	_	630	-	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 600 V, T_{J} = 25 $^{\circ}C$	-	-	10	μA
Gate-to-Source Leakage Current	I _{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I_D = 29.5 A, T_J = 25 $^\circ C$	_	32	40	mΩ
Gate Threshold Voltage	V _{GS(th)}	V_{GS} = V_{DS} , I_D = 7.2 mA, T_J = 25°C	3.2	-	4.8	V
Forward Trans-conductance	9FS	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 29.5 \text{ A}$	-	59.5	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE	•				
Input Capacitance	C _{ISS}	V_{DS} = 400 V, V_{GS} = 0 V, f = 250 kHz	_	6318	-	pF
Output Capacitance	C _{OSS}		_	98.9	-	
Time Related Output Capacitance	C _{OSS(tr.)}	$I_{D} = Constant, V_{DS} = 0 V to 400 V, \\ V_{GS} = 0 V$	_	1478	-	
Energy Related Output Capacitance	C _{OSS(er.)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	_	170	-	
Total Gate Charge	Q _{G(tot)}	V_{DD} = 400 V, I_{D} = 29.5 A, V_{GS} = 10 V	-	115	-	nC
Gate-to-Source Charge	Q _{GS}		-	35.9	-	1
Gate-to-Drain Charge	Q _{GD}		_	32.7	-	
Gate Resistance	R _G	f = 1 MHz	-	4.5	-	Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	V_{GS} = 0/10 V, V_{DD} = 400 V, I _D = 29.5 A, R _G = 2.2 Ω	_	49.6	-	ns
Rise Time	t _r		_	85.9	-	
Turn-Off Delay Time	t _{d(off)}	1	_	110	-	
Fall Time	t _f	1	-	2.5	-	
SOURCE-TO-DRAIN DIODE CHARAC	TERISTICS	· · · · · · · · · · · · · · · · · · ·		-		-
Forward Diode Voltage	V _{SD}	V_{GS} = 0 V, I _{SD} = 29.5 A, T _J = 25°C	_	-	1.2	V

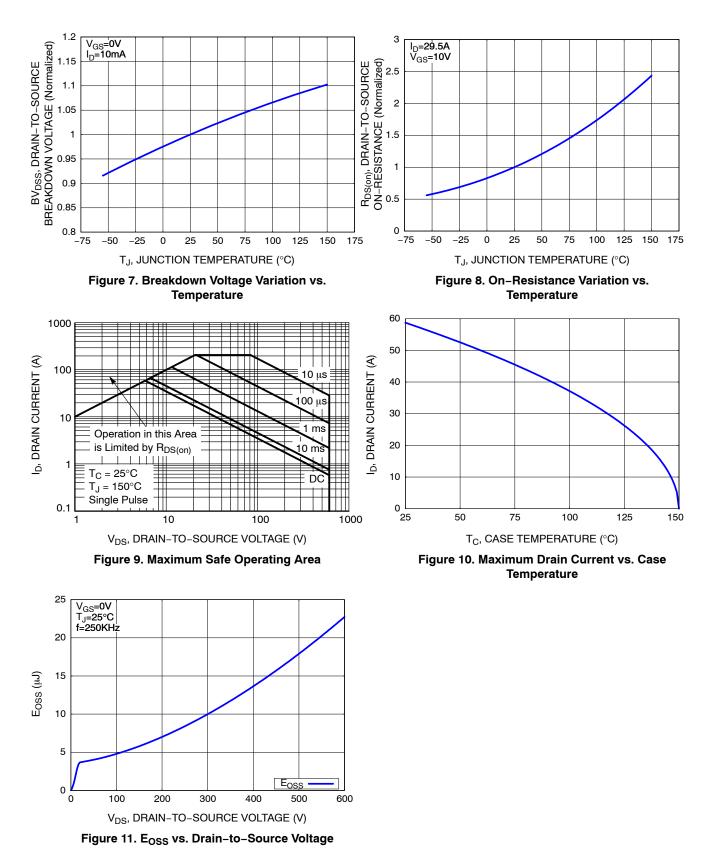
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _{SD} = 29.5 A, T _J = 25°C	-	-	1.2	V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 V, I_{SD} = 29.5 A,$	-	140	-	ns
Reverse Recovery Charge	Q _{RR}	dl/dt = 100 A/µs, V _{DD} = 400 V	1	917	1	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS

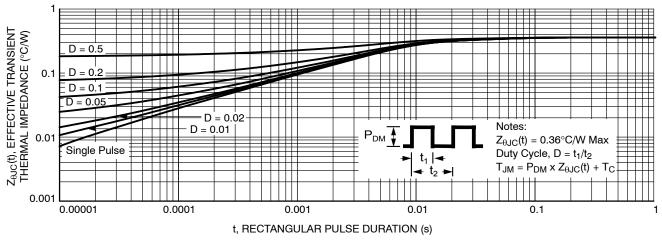


Figure 12. Transient Thermal Impedance

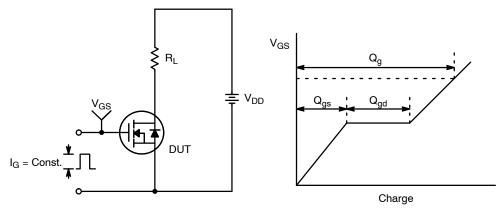


Figure 13. Gate Charge Test Circuit & Waveform

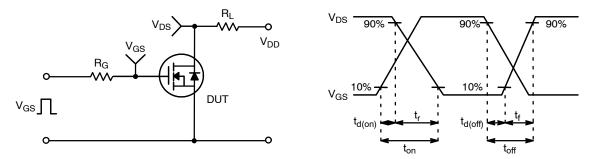


Figure 14. Resistive Switching Test Circuit & Waveforms

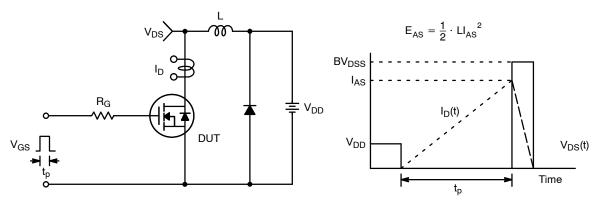


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

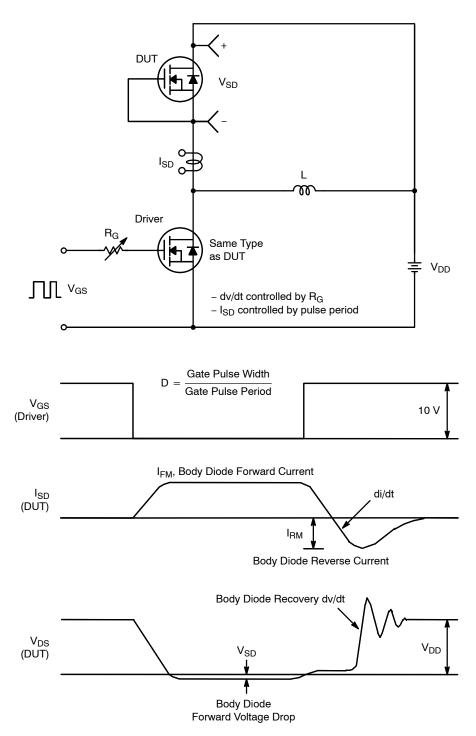
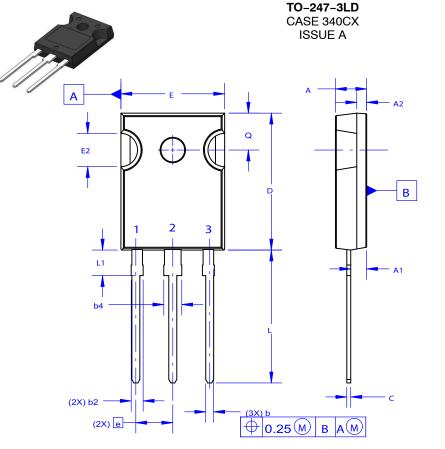


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

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GENERIC **MARKING DIAGRAM*** Х



XXXXX	= Specific Device Code
Α	= Assembly Location

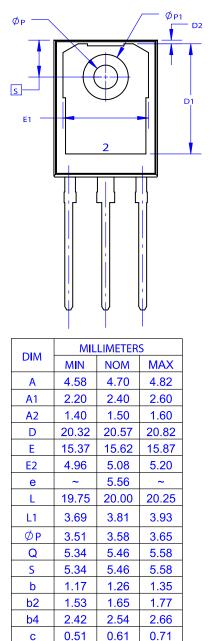
- = Assembly Location
- = Year
- ww = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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DATE 06 JUL 2020



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